



# Addendum Sheet

## ***In-Sight<sup>®</sup> Micro Series Vision System Installation Manual***

The In-Sight<sup>®</sup> Micro series of vision systems now includes the In-Sight 1402. This addendum includes hardware specifications to support this vision system, along with updates and corrections to existing precautions and regulations/conformity information. This information will be included in the next revision of the *In-Sight<sup>®</sup> Micro Series Vision System Installation Manual*. Please keep this addendum with your installation manual.

# Regulations/Conformity

**Note:** For the most up-to-date regulations and conformity information, please refer to the In-Sight online support site: <http://www.cognex.com/Support/InSight>.

<b>Declaration of Conformity</b>	
Manufacturer	Cognex Corporation One Vision Drive Natick, MA 01760 USA
Declares this  -marked Machine Vision System Product	
Product Type	In-Sight Micro 1020/1050/1100/1110/1400/1410: Type 821-0043-1R In-Sight Micro 1100C/1400C: Type 821-0044-1R In-Sight Micro 1402: Type 821-0078-1R In-Sight Micro 1403/1413: Type 821-0047-1R In-Sight Micro 1403C: Type 821-0048-1R
Complies With	2004/108/EC Electromagnetic Compatibility Directive
Compliance Standards	EN 55022:2006 + A1:2007 Class A EN 61000-6-2:2005
European Representative	COGNEX INTERNATIONAL Immeuble "Le Patio" 104 Avenue Albert 1er 92563 Rueil Malmaison Cedex - France
<b>Safety and Regulatory</b>	
FCC	FCC Part 15, Class A This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference; and (2) this device must accept any interference received, including interference that may cause undesired operation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at their own expense.
KCC 	In-Sight Micro 1020/1050/1100/1110/1400/1410: CGX-ISM1400-00(A) In-Sight Micro 1100C/1400C: CGX-ISM1400-C00(A) In-Sight Micro 1402: KCC-REM-CGX-ISM1402-01 In-Sight Micro 1403/1413: CGX-ISM1403-00(A) In-Sight Micro 1403C: CGX-ISM1403-C00(A)
NRTL	TÜV SÜD AM SCC/NRTL OSHA Scheme for UL/CAN 60950-1.
CB	TÜV SÜD AM, IEC/EN 60950-1. CB report available upon request.
RoHS	RoHS 6 Compliant.

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# Precautions

Observe these precautions when installing the vision system to reduce the risk of injury or equipment damage:

- An IEEE 802.3af compliant, and UL or NRTL listed, Power over Ethernet (PoE) power source rated Class 0, 2, 3 or 4 must be used. Any other voltage creates a risk of fire or shock and can damage the In-Sight vision system components. Applicable local and national wiring standards and rules must be followed.
- To reduce the risk of damage or malfunction due to over-voltage, line noise, electrostatic discharge (ESD), power surges, or other irregularities in the power supply, route all cables and wires away from high-voltage power sources.
- Do not install In-Sight vision systems where they are directly exposed to environmental hazards such as excessive heat, dust, moisture, humidity, impact, vibration, corrosive substances, flammable substances, or static electricity.
- Do not expose the image sensor to laser light; image sensors can be damaged by direct, or reflected, laser light. If your application requires the use of laser light that may strike the image sensor, a lens filter at the corresponding laser's wavelength is recommended. Contact your local integrator or application engineer for suggestions.
- The In-Sight vision system does not contain user-serviceable parts. Do not make electrical or mechanical modifications to In-Sight vision system components. Unauthorized modifications may void your warranty.
- Changes or modifications not expressly approved by the party responsible for regulatory compliance could void the user's authority to operate the equipment.
- Service loops should be included with all cable connections.
- Cable shielding can be degraded or cables can be damaged or wear out more quickly if a bend radius or service loop is tighter than 10X the cable diameter.
- Class A Equipment (broadcasting and communication equipment for office work): Seller and user shall be notified that this equipment is suitable for electromagnetic equipment for office work (Class A) and can be used outside the home.
- This device should be used in accordance with the instructions in this manual.

# Specifications

The following sections list general specifications for the In-Sight Micro vision systems.

## In-Sight Micro Vision System Specifications

**Table 4-1: In-Sight Micro Vision System Specifications**

Specifications	1020/1050	1100/1110	1100C	1400/1410	1400C	1402	1403/1413	1403C	
Minimum Firmware Requirement	In-Sight version 4.4.3					In-Sight version 4.6.0	In-Sight version 4.4.3		
Job/Program Memory	128MB non-volatile flash memory; unlimited storage via remote network device.								
Image Processing Memory	256MB								
Sensor Type	1/3-inch CCD					1/1.8-inch CMOS	1/1.8-inch CCD		
Sensor Properties	5.92mm diagonal, 7.4 x 7.4µm sq. pixels					8.7mm diagonal, 5.3 x 5.3µm sq. pixels	8.8mm diagonal, 4.4 x 4.4µm sq. pixels		
Resolution (pixels)	640 x 480					1280 x 1024	1600 x 1200		
Electronic Shutter Speed	16µs to 1000ms						52µs to 1000ms		
Acquisition	Rapid reset, progressive scan, full-frame integration.								
Bit Depth	256 grey levels (8 bits/pixel)	24 bit color		256 grey levels (8 bits/pixel)	24 bit color	256 grey levels (8 bits/pixel)	24 bit color		
Image Gain/Offset	Controlled by software.								
Frames Per Second <sup>1</sup>	60 full frames per second	58 full frames per second	60 full frames per second	58 full frames per second	60 full frames per second	14 full frames per second	7 full frames per second		
Lens Type	CS-mount and C-mount (with 5mm extension, included).								
Image Sensor Alignment Variability <sup>2</sup>	±0.127mm (0.005in), (both x and y) from lens C-mount axis to center of imager.								
Trigger	1 opto-isolated, acquisition trigger input. Remote software commands via Ethernet. (RS-232C available when using the optional CIO-MICRO or CIO-MICRO-CC I/O module.)								
Discrete Inputs	None. (Eight additional inputs available when using the optional CIO-MICRO or CIO-MICRO-CC I/O module.)								
Discrete Outputs	2 opto-isolated, NPN/PNP high-speed outputs. (Eight additional outputs available when using the optional CIO-MICRO or CIO-MICRO-CC I/O module.)								
Status LEDs	Network, 2 user-configurable.								

<sup>1</sup> Maximum frames per second is job-dependent and based on the minimum exposure for a full image frame capture.

<sup>2</sup> Expected variability in the physical position of the image sensor, from vision system-to-vision system. This equates to ~ ±17 pixels on a 640 x 480 resolution CCD, ~ ±24 pixels on a 1280 x 1024 resolution CMOS and ~ ±29 pixels on a 1600 x 1200 resolution CCD.

Specifications	1020/1050	1100/1110	1100C	1400/1410	1400C	1402	1403/1413	1403C
Network Communication	1 Ethernet port, 10/100 BaseT with auto MDI/MDIX. Supports DHCP (factory default), static and link-local IP address configuration.							
Serial Communication	None. (RS-232C: 4800 to 115,200 baud rates when connected to the optional CIO-MICRO or CIO-MICRO-CC I/O module).							
Power	Class 2 Power over Ethernet (PoE) device.							
Power Type	A and B.							
Power Consumption	6.49 W maximum per Class 2 PoE.							
Current	Per Class 2 PoE requirements.							
Voltage	48 V nominal, applied from a Class 2 PoE injector which is typically powered from some other voltage.							
Material	Die-cast zinc housing.							
Finish	Painted							
Mounting	Four M3 threaded mounting holes (1/4 - 20 and M6 mounting holes also available on mounting block).							
Dimensions	30mm (1.18in) x 30mm (1.18in) x 60mm (2.36in) without mounting block. 30mm (1.18in) x 38.2mm (1.50in) x 60mm (2.36in) with mounting block.							
Weight	121g (4.27oz.) without mounting block. 146g (5.15oz.) with mounting block.							
Temperature	Operating: 0°C to 45°C (32°F to 113°F) Storage: -30°C to 80°C (-22°F to 176°F)							
Humidity	90%, non-condensing (Operating and Storage)							
Protection	IP51 with cables and lens attached.							
Shock	80 G shock with 50 gram or lighter lens attached per IEC 68-2-27 EA.							
Vibration	10 G with 50 gram or lighter lens attached 2 hrs/axis (10-500 Hz) per IEC 68-2-6, FC.							
Regulatory Compliance	CE, FCC, KCC, TÜV SÜD NRTL, RoHS							

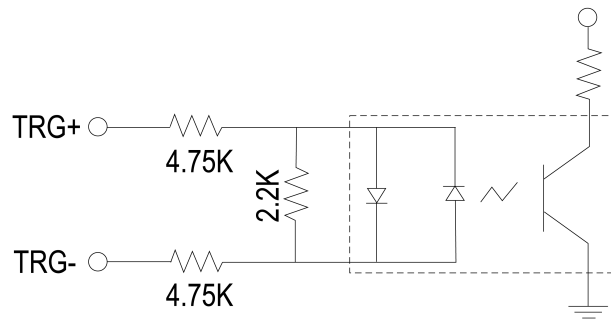
## Acquisition Trigger Input

**Table 4-2: Acquisition Trigger Input Specifications**

Specification	Description	
Voltage	ON	20 to 28V (24V nominal)
	OFF	0 to 3V (8V nominal threshold)
Current	ON	2.0 to 2.9mA
	OFF	< 250µA
	Resistance	~10,000 Ohms
Delay <sup>1</sup>	In-Sight Micro 1020, 1050, 1100, 1100C, 1110, 1400, 1400C, 1402 & 1410	63µs maximum latency between leading edge of trigger and start of acquisition. Input pulse should be minimum of 1 ms wide.
	In-Sight Micro 1403 & 1413	81µs maximum latency between leading edge of trigger and start of acquisition. Input pulse should be minimum of 1 ms wide.
	In-Sight Micro 1403C	116µs maximum latency between leading edge of trigger and start of acquisition. Input pulse should be minimum of 1 ms wide.

The acquisition trigger input is opto-isolated. To trigger from an NPN (pull-down) type photoelectric sensor or PLC output, connect pin 3 (TRG+) to +24V and connect pin 4 (TRG-) to the output of the photoelectric sensor.

When the output turns ON, it pulls TRG- down to 0V, turning the opto-coupler ON. To trigger from a PNP (pull-up) photoelectric sensor or PLC output, connect pin 3 (TRG+) to the output of the photoelectric sensor and connect pin 4 (TRG-) to 0V. When the output turns ON, it pulls TRG+ up to 24V, turning the opto-coupler ON.



28V Max. Across input pins - Transition approx. 8V (Nom).

**Figure 4-1: Acquisition Trigger Input Schematic**



P/N 597-0136-01  
Printed in the USA

<sup>1</sup> Maximum latency is based on a 1µs trigger debounce.